

1A, 200V-1000V Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.029g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	1	A
V_{RRM}	200-1000	V
I_{FSM}	30	A
$T_{J\ MAX}$	150	°C
Package	Thin SMA	
Configuration	Single Die	



Thin SMA



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	S1DALH	S1GALH	S1JALH	S1KALH	S1MALH	UNIT
Marking code on the device		S1DAH	S1GAH	S1JAH	S1KAH	S1MAH	
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V
Forward current	I_F	1					A
Surge peak forward current, single half sine-wave superimposed on rated load	$t = 8.3\text{ms}$	30					A
	$t = 1.0\text{ms}$	100					A
Junction temperature	T_J	-55 to +150					°C
Storage temperature	T_{STG}	-55 to +150					°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	29	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	82	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	30	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 0.5\text{A}, T_J = 25^\circ\text{C}$	V_F	0.90	-	V
	$I_F = 1.0\text{A}, T_J = 25^\circ\text{C}$		0.96	1.10	V
	$I_F = 0.5\text{A}, T_J = 125^\circ\text{C}$		0.78	-	V
	$I_F = 1.0\text{A}, T_J = 125^\circ\text{C}$		0.85	0.98	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	1	μA
	$T_J = 125^\circ\text{C}$		-	50	μA
Junction capacitance	1MHz, $V_R = 4.0\text{V}$	C_J	8	-	pF

Notes:

- (1) Pulse test with PW = 0.3ms
- (2) Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE⁽¹⁾	PACKAGE	PACKING
S1xALH M3G	Thin SMA	3,500 / 7" reel
S1xALH M2G	Thin SMA	14,000 / 13" reel

Notes:

- (1) "x" defines voltage from 200V(S1DALH) to 1000V(S1MALH)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

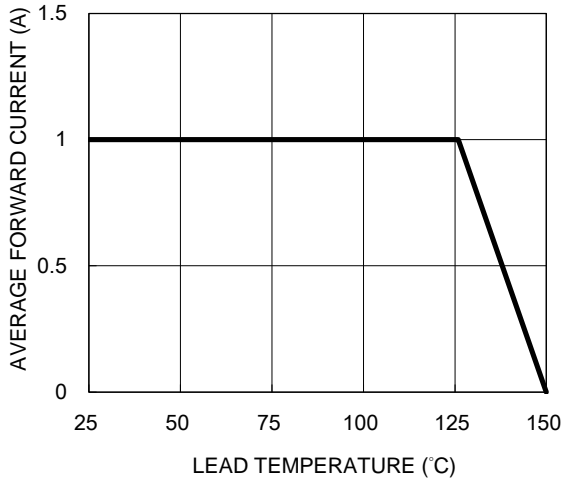


Fig.2 Typical Junction Capacitance

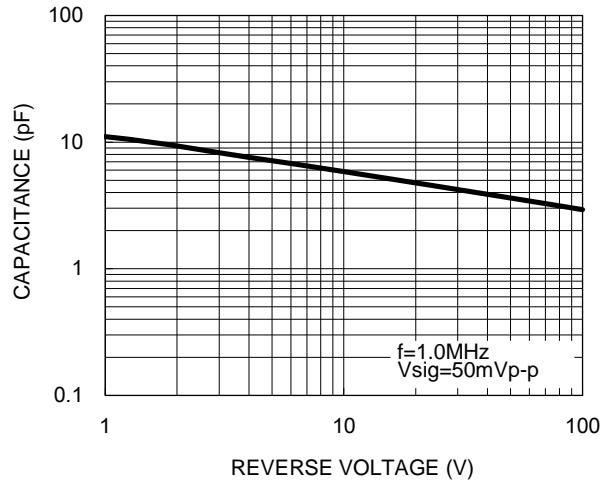


Fig.3 Typical Reverse Characteristics

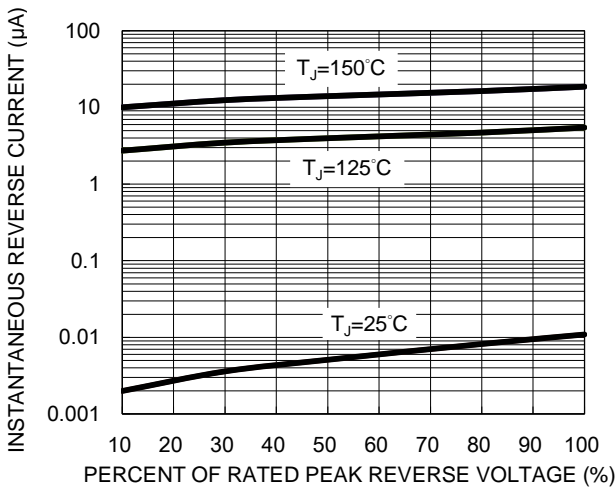


Fig.4 Typical Forward Characteristics

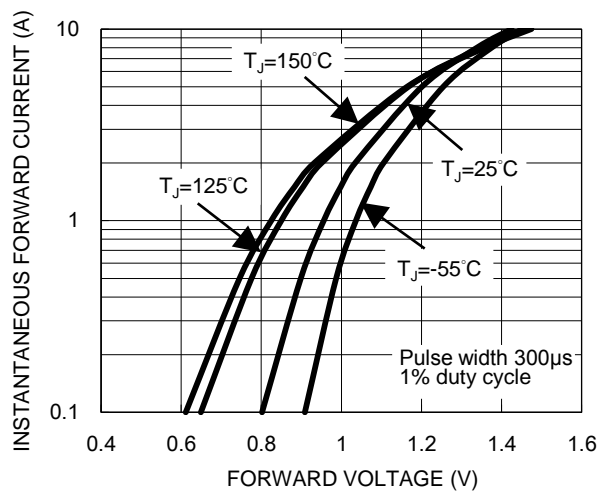
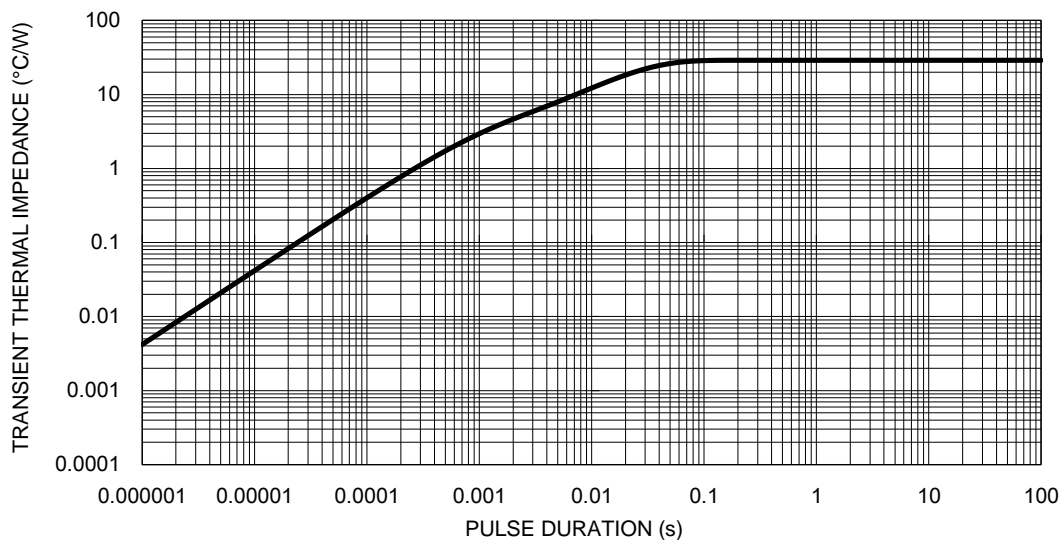
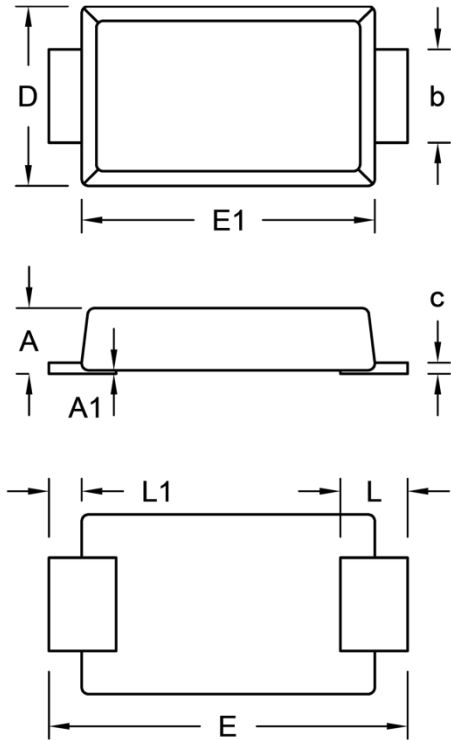


Fig.5 Typical Transient Thermal Impedance



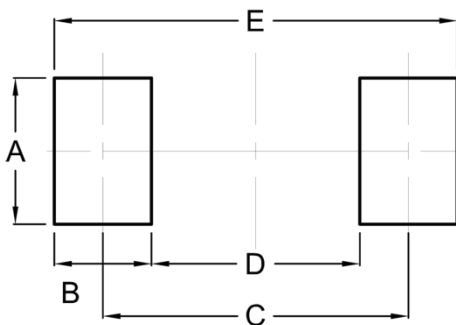
PACKAGE OUTLINE DIMENSIONS

Thin SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
c	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code
 YW = Date Code
 F = Factory Code

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